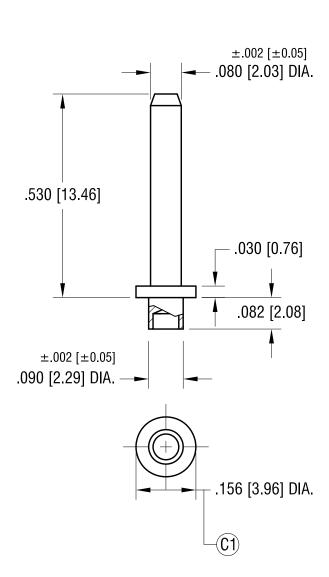
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## **ACTUAL SIZE**





NOTE:

1. MOUNTING HOLE .094 [2.38]

			www.keyeico.com ● NEW HTD
			PART NAME
			MICRO PIN,
	(C1) TOLERANCE WAS ±.002		MATERIAL
5.17.2		С	В
			FINISH
3.10.1	CHANGE AS PER ECN 11-035	В	TIN PLATE
4.16.08	CHANGE AS PER ECN 08-101	Α	TOLERANCES INCH [MM] CO
DATE	DESCRIPTION	REV.	ANGULAR ± 1° UNLESS OTHERWISE SPECIFIED

KEYSTONE ELECTRONICS CORP.					
www.keyelco.com   NEW HYDE PARK, NY 11040  Tel (516) 328-7500					
PART NAME					
MICRO PIN, SWAGE MOUNT					
MATERIAL					
BRASS					
FINISH TIN PLATE	BOONE DATE 2.22.07				
I IIN PLATE	RH SCALE 4X				
TOLERANCES INCH [MM] CODE	DWG NO.				
DECIMAL ± .005 [± 0.13 ] ANGULAR ± 1° UNLESS OTHERWISE SPECIFIED	1365-2				